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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	40/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	8KB (8K x 8)
Program Memory Type	ОТР
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-QFP
Supplier Device Package	44-PQFP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ts87c52x2-mic

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Table 2. All SFRs with their address and their reset value

	Bit Addressable	Non Bit Addressable								
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F		
F8h									FFh	
F0h	B 0000 0000								F7h	
E8h									EFh	
E0h	ACC 0000 0000								E7h	
D8 h									DFh	
D0 h	PSW 0000 0000								D7h	
C8 h	T2CON 0000 0000	T2MOD XXXX XX00	RCAP2L 0000 0000	RCAP2H 0000 0000	TL2 0000 0000	TH2 0000 0000			CFh	
C0 h									C7h	
B8h	IP XX00 0000	SADEN 0000 0000							BFh	
B0h	P3 1111 1111							IPH XX00 0000	B7h	
A8h	IE 0X00 0000	SADDR 0000 0000							AFh	
A0h	P2 1111 1111		AUXR1 XXXX XXX0						A7h	
98h	SCON 0000 0000	SBUF XXXX XXXX							9Fh	
90h	P1 1111 1111								97h	
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR XXXXXXX0	CKCON XXXX XXX0	8Fh	
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h	
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F		

Reserved



TS80C52X2 Enhanced Features

In comparison to the original 80C52, the TS80C52X2 implements some new features, which are:

- The X2 option
- The Dual Data Pointer
- The 4 level interrupt priority system
- The power-off flag
- The ONCE mode
- The ALE disabling
- Some enhanced features are also located in the UART and the Timer 2

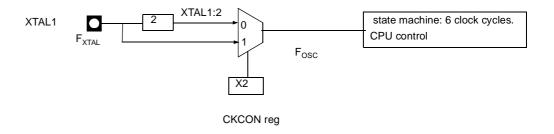
X2 Feature The TS80C52X2 core needs only 6 clock periods per machine cycle. This feature called "X2" provides the following advantages:

- Divide frequency crystals by 2 (cheaper crystals) while keeping same CPU power
- Save power consumption while keeping same CPU power (oscillator power saving)
- Save power consumption by dividing dynamically operating frequency by 2 in operating and idle modes
- Increase CPU power by 2 while keeping same crystal frequency

In order to keep the original C51 compatibility, a divider by 2 is inserted between the XTAL1 signal and the main clock input of the core (phase generator). This divider may be disabled by software.

DescriptionThe clock for the whole circuit and peripheral is first divided by two before being used by
the CPU core and peripherals. This allows any cyclic ratio to be accepted on XTAL1
input. In X2 mode, as this divider is bypassed, the signals on XTAL1 must have a cyclic
ratio between 40 to 60%. Figure 1. shows the clock generation block diagram. X2 bit is
validated on XTAL1÷2 rising edge to avoid glitches when switching from X2 to STD
mode. Figure 2 shows the mode switching waveforms.

Figure 1. Clock Generation Diagram



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Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.

ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Destroys DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added 00A2 AUXR1 EQU 0A2H 0000 909000MOV DPTR,#SOURCE ; address of SOURCE 0003 05A2 INC AUXR1 ; switch data pointers 0005 90A000 MOV DPTR,#DEST ; address of DEST 0008 LOOP: 0008 05A2 INC AUXR1 ; switch data pointers 000A E0 MOVX A, atDPTR ; get a byte from SOURCE 000B A3 INC DPTR ; increment SOURCE address 000C 05A2 INC AUXR1 ; switch data pointers 000E F0 MOVX atDPTR, A ; write the byte to DEST 000F A3 INC DPTR ; increment DEST address 0010 70F6JNZ LOOP ; check for 0 terminator 0012 05A2 INC AUXR1 ; (optional) restore DPS

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.



Timer 2	The timer 2 in the TS80C52X2 is compatible with the timer 2 in the 80C52. It is a 16-bit timer/counter: the count is maintained by two eight-bit timer registers, TH2 and TL2, connected in cascade. It is controlled by T2CON register (See Table 5) and T2MOD register (See Table 6). Timer 2 operation is similar to Timer 0 and Timer 1. C/T2 selects $F_{OSC}/12$ (timer operation) or external pin T2 (counter operation) as the timer clock input. Setting TR2 allows TL2 to be incremented by the selected input.
	Timer 2 has 3 operating modes: capture, autoreload and Baud Rate <u>Generator</u> . These modes are selected by the combination of RCLK, TCLK and CP/RL2 (T2CON), as described in the Atmel 8-bit Microcontroller Hardware description.
	Refer to the Atmel 8-bit Microcontroller Hardware description for the description of Cap- ture and Baud Rate Generator Modes.
	In TS80C52X2 Timer 2 includes the following enhancements:
	Auto-reload mode with up or down counter
	Programmable clock-output
Auto-reload Mode	The Auto-reload mode configures timer 2 as a 16-bit timer or event counter with auto- matic reload. If DCEN bit in T2MOD is cleared, timer 2 behaves as in 80C52 (refer to the Atmel 8-bit Microcontroller Hardware description). If DCEN bit is set, timer 2 acts as an Up/down timer/counter as shown in Figure 4. In this mode the T2EX pin controls the direction of count.
	When T2EX is high, timer 2 counts up. Timer overflow occurs at FFFFh which sets the TF2 flag and generates an interrupt request. The overflow also causes the 16-bit value in RCAP2H and RCAP2L registers to be loaded into the timer registers TH2 and TL2.
	When T2EX is low, timer 2 counts down. Timer underflow occurs when the count in the timer registers TH2 and TL2 equals the value stored in RCAP2H and RCAP2L registers. The underflow sets TF2 flag and reloads FFFFh into the timer registers.
	The EXF2 bit toggles when timer 2 overflows or underflows according to the the direc- tion of the count. EXF2 does not generate any interrupt. This bit can be used to provide

17-bit resolution.

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Table 5	T2CON	Register
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T2CON - Timer 2 Control Register (C8h)

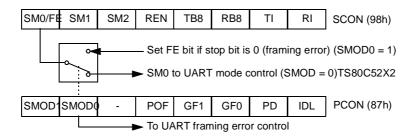
7	6	5	4	3	2	1	0				
TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2#	CP/RL2#				
Bit Number	Bit Mnemonic	Description									
7	TF2	Must be cleare	Timer 2 overflow Flag Must be cleared by software. Set by hardware on timer 2 overflow, if RCLK = 0 and TCLK = 0.								
6	EXF2	Set when a ca EXEN2=1. When set, cau interrupt is ena Must be cleare	Timer 2 External Flag Set when a capture or a reload is caused by a negative transition on T2EX pin if								
5	RCLK	Receive Clock Clear to use time Set to use time	mer 1 overflov			•					
4	TCLK	Transmit Cloc Clear to use tin Set to use time	mer 1 overflov			•					
3	EXEN2	Timer 2 Exter Clear to ignore Set to cause a detected, if tim	e events on Ta capture or re	2EX pin for tim load when a n	egative transi		pin is				
2	TR2	Timer 2 Run of Clear to turn of Set to turn on	ff timer 2.								
1	C/T2#	Clear for timer Set for counter	Timer/Counter 2 select bit Clear for timer operation (input from internal clock system: F _{OSC}). Set for counter operation (input from T2 input pin, falling edge trigger). Must be 0 for clock out mode.								
0	CP/RL2#	Timer 2 Captu If RCLK=1 or 7 timer 2 overflo Clear to Auto-r EXEN2=1. Set to capture	CLK=1, CP/F w. eload on time	RL2# is ignored er 2 overflows o	or negative tra	ansitions on T2					

Reset Value = 0000 0000b Bit addressable



TS80C52X2 Serial I/O
PortThe serial I/O port in the TS80C52X2 is compatible with the serial I/O port in the 80C52.
It provides both synchronous and asynchronous communication modes. It operates as
an Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex
modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simul-
taneously and at different baud rates
Serial I/O port includes the following enhancements:
 Framing Error DetectionFraming bit error detection is provided for the three asynchronous modes (modes 1, 2
and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON regis-
ter (See Figure 6).

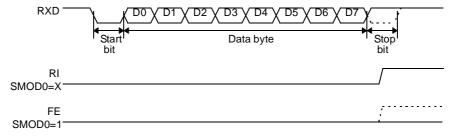
Figure 6. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Table 9.) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 7. and Figure 8.).

Figure 7. UART Timings in Mode 1





1111 0000b).
For slave A, bit 1 is a 1; for slaves B and C, bit 1 is a don't care bit. To communicate with slaves B and C, but not slave A, the master must send an address with bits 0 and 1 both set (e.g. 1111 0011b).
To communicate with slaves A, B and C, the master must send an address with bit 0 set, bit 1 clear, and bit 2 clear (e.g. 1111 0001b).

Broadcast Address A broadcast address is formed from the logical OR of the SADDR and SADEN registers with zeros defined as don't-care bits, e.g.:

SADDR 0101 0110b SADEN 1111 1100b Broadcast =SADDR OR SADEN1111 111Xb

The use of don't-care bits provides flexibility in defining the broadcast address, however in most applications, a broadcast address is FFh. The following is an example of using broadcast addresses:

Slave A:SADDR1111 0001b <u>SADEN1111 1010b</u> Broadcast1111 1X11b, Slave B:SADDR1111 0011b <u>SADEN1111 1001b</u> Broadcast1111 1X11B,

Slave C:SADDR=1111 0010b <u>SADEN1111 1101b</u> Broadcast1111 1111b

For slaves A and B, bit 2 is a don't care bit; for slave C, bit 2 is set. To communicate with all of the slaves, the master must send an address FFh. To communicate with slaves A and B, but not slave C, the master can send and address FBh.

Reset AddressesOn reset, the SADDR and SADEN registers are initialized to 00h, i.e. the given and
broadcast addresses are XXXX XXXb (all don't-care bits). This ensures that the serial
port will reply to any address, and so, that it is backwards compatible with the 80C51
microcontrollers that do not support automatic address recognition.

 Table 7.
 SADEN Register

7	6	5	4	3	2	1	0
Decet Valu		0006			<u>.</u>		
Reset Valu		0000					
Not bit add	ressable						
Table 8 S		vietor					
	-						
	-		er (A9h)				
Table 8. S SADDR - S 7	-		er (A9h) 4	3	2	1	0
SADDR - S	lave Addre	ess Registe	er (A9h) 4	3	2	1	0
SADDR - S	lave Addre	ess Registe	er (A9h) 4	3	2	1	0

Not bit addressable



Table 10. PCON RegisterPCON - Power Control Register (87h)

7	6	5	4	3	2	1	0
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL
Bit Number	Bit Mnemonic	Descriptio	n				
7	SMOD1		t Mode bit 1 act double bau	ud rate in mode	e 1, 2 or 3.		
6	SMOD0	Clear to se		n SCON regist SCON registe			
5	-	Reserved The value	read from this	bit is indeterm	ninate. Do not	set this bit.	
4	POF		cognize next i dware when V	reset type. /CC rises from	0 to its nomina	al voltage. Ca	n also be set
3	GF1	Cleared by		eral purpose us purpose usage			
2	GF0	Cleared by	-	eral purpose us purpose usage	-		
1	PD	Cleared by	wn mode bit hardware wh r power-down	ien reset occui n mode.	rs.		
0	IDL	-		i interrupt or re	eset occurs.		

Reset Value = 00X1 0000b Not bit addressable

Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.





Table 13. IP RegisterIP - Interrupt Priority Register (B8h)

7	6	5	4	3	2	1	0				
-	-	PT2	PS	PT1	PX1	PT0	PX0				
Bit Number	Bit Mnemonic	Descriptio	Description								
7	-	Reserved The value	Reserved The value read from this bit is indeterminate. Do not set this bit.								
6	-	Reserved The value	read from this	bit is indetern	ninate. Do not	set this bit.					
5	PT2		erflow interr 2H for priority	upt Priority b y level.	it						
4	PS		t Priority bit SH for priority	level.							
3	PT1		erflow interr	upt Priority b y level.	it						
2	PX1		nterrupt 1 Pri	•							
1	PT0		erflow interr	upt Priority b y level.	it						
0	PX0		nterrupt 0 Pri								

Reset Value = XX00 0000b Bit addressable

Table 14.IPH RegisterIPH - Interrupt Priority High Register (B7h)

7	6	5	4	3	2	1	0
-	-	PT2H	PSH	PT1H	PX1H	РТОН	РХОН
Bit Number	Bit Mnemonic	Description					
7	-	Reserved The value rea	d from this bit	is indetermina	ate. Do not se	t this bit.	
6	-	Reserved The value rea	d from this bit	is indetermina	ate. Do not se	t this bit.	
5	PT2H	Timer 2 over PT2H PT2 0 0 1 0 1 1	f low interrup <u>Priority Leve</u> Lowest Highest	t Priority High 한	n bit		
4	PSH	Serial port P PSH PS 0 0 0 1 1 0 1 1	riority High b <u>Priority Leve</u> Lowest Highest				
3	PT1H	Timer 1 over PT1H PT1 0 0 0 1 1 0 1 1		t Priority High 키	n bit		
2	PX1H	External inte PX1H PX1 0 0 1 0 1 1 1 1	rrupt 1 Priori Priority Leve Lowest Highest				
1	РТОН	Timer 0 over PT0H PT0 0 0 1 0 1 1		t Priority High 한	n bit		
0	РХОН	External inte PX0H PX0 0 0 1 1 1 1	rrupt 0 Priori <u>Priority Leve</u> Lowest Highest	ty High bit <u>키</u>			

Reset Value = XX00 0000b Not bit addressable



Exit from power-down by reset redefines all the SFRs, exit from power-down by external interrupt does no affect the SFRs.

Exit from power-down by either reset or external interrupt does not affect the internal RAM content.

Note: If idle mode is activated with power-down mode (IDL and PD bits set), the exit sequence is unchanged, when execution is vectored to interrupt, PD and IDL bits are cleared and idle mode is not entered.

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Port Data ⁽¹⁾	Port Data	Port Data	Port Data
Idle	External	1	1	Floating	Port Data	Address	Port Data
Power Down	Internal	0	0	Port Data ⁽¹⁾	Port Data	Port Data	Port Data
Power Down	External	0	0	Floating	Port Data	Port Data	Port Data

Table 15. The State of Ports During Idle and Power-down Modes

Note: 1. Port 0 can force a "zero" level. A "one" will leave port floating.





ONCE[™] Mode (ON Chip Emulation)

The ONCE mode facilitates testing and debugging of systems using TS80C52X2 without removing the circuit from the board. The ONCE mode is invoked by driving certain pins of the TS80C52X2; the following sequence must be exercised:

- Pull ALE low while the device is in reset (RST high) and PSEN is high.
- Hold ALE low as RST is deactivated.

While the TS80C52X2 is in ONCE mode, an emulator or test CPU can be used to drive the circuit Table 26. shows the status of the port pins during ONCE mode.

Normal operation is restored when normal reset is applied.

Table 16. External Pin Status during ONCE Mode

ALE	PSEN	Port 0	Port 1	Port 2	Port 3	XTAL1/2
Weak pull- up	Weak pull- up	Float	Weak pull- up	Weak pull- up	Weak pull- up	Active



EPROM Structure The TS87C52X2 is divided in two different arrays:

- the code array: 8 Kbytes
- the encryption array: 64 bytes

In addition a third non programmable array is implemented:

the signature array: 4 bytes

EPROM Lock System The program Lock system, when programmed, protects the on-chip program against software piracy.

Encryption Array Within the EPROM array are 64 bytes of encryption array that are initially unprogrammed (all FF's). Every time a byte is addressed during program verify, 6 address lines are used to select a byte of the encryption array. This byte is then exclusive-NOR'ed (XNOR) with the code byte, creating an encrypted verify byte. The algorithm, with the encryption array in the unprogrammed state, will return the code in its original, unmodified form.

When using the encryption array, one important factor needs to be considered. If a byte has the value FFh, verifying the byte will produce the encryption byte value. If a large block (>64 bytes) of code is left unprogrammed, a verification routine will display the content of the encryption array. For this reason all the unused code bytes should be programmed with random values. This will ensure program protection.

Program Lock Bits The three lock bits, when programmed according to Table 1., will provide different level of protection for the on-chip code and data.

Program Lock Bits				
Security level	LB1	LB2	LB3	Protection Description
1	U	U	U	No program lock features enabled. Code verify will still be encrypted by the encryption array if programmed. MOVC instruction executed from external program memory returns non encrypted data.
2	Ρ	U	U	MOVC instruction executed from external program memory are disabled from fetching code bytes from internal memory, EA is sampled and latched on reset, and further programming of the EPROM is disabled.
3	U	Р	U	Same as 2, also verify is disabled.
4	U	U	Р	Same as 3, also external execution is disabled.

U: unprogrammed P: programmed

WARNING: Security level 2 and 3 should only be programmed after EPROM and Core verification.

Signature Bytes The TS80/87C52X2 contains 4 factory programmed signatures bytes. To read these bytes, perform the process described in section 9.

EPROM Programming

Set-up modes

In order to program and verify the EPROM or to read the signature bytes, the TS87C52X2 is placed in specific set-up modes (See Figure 11.).



Electrical Characteristics

Absolute Maximum Ratings⁽¹⁾

Ambiant Temperature Under Bias:	
C = commercial	0°C to 70°C
I = industrial	40°C to 85°C
Storage Temperature	65°C to + 150°C
Voltage on V _{CC} to V _{SS}	0.5V to + 7 V
Voltage on V _{PP} to V _{SS}	0.5V to + 13 V
Voltage on Any Pin to V _{SS}	0.5V to V _{CC} + 0.5V
Power Dissipation	1 W ⁽²⁾

- Notes: 1. Stresses at or above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
 - 2. This value is based on the maximum allowable die temperature and the thermal resistance of the package.

Power Consumption Measurement Since the introduction of the first C51 devices, every manufacturer made operating lcc measurements under reset, which made sense for the designs were the CPU was running under reset. In Atmel new devices, the CPU is no more active during reset, so the power consumption is very low but is not really representative of what will happen in the customer system. That's why, while keeping measurements under Reset, Atmel presents a new way to measure the operating lcc:

Using an internal test ROM, the following code is executed:

Label: SJMP Label (80 FE)

Ports 1, 2, 3 are disconnected, Port 0 is tied to FFh, EA = Vcc, RST = Vss, XTAL2 is not connected and XTAL1 is driven by the clock.

This is much more representative of the real operating Icc.

DC Parameters for	TA = 0°C to +70°C; V_{SS} = 0 V; V_{CC} = 5V ± 10%; F = 0 to 40 MHz.
Standard Voltage	TA = -40°C to +85°C; $V_{SS} = 0$ V; $V_{CC} = 5V \pm 10\%$; F = 0 to 40 MHz.

Table 22.	DC Parameters	in	Standard	Voltage
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Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
V _{IL}	Input Low Voltage	-0.5		0.2 V _{CC} - 0.1	V	
V _{IH}	Input High Voltage except XTAL1, RST	0.2 V _{CC} + 0.9		V _{CC} + 0.5	V	
V _{IH1}	Input High Voltage, XTAL1, RST	0.7 V _{CC}		V _{CC} + 0.5	V	
V _{OL}	Output Low Voltage, ports 1, 2, 3 ⁽⁶⁾			0.3 0.45 1.0	V V V	$I_{OL} = 100 \ \mu A^{(4)}$ $I_{OL} = 1.6 \ m A^{(4)}$ $I_{OL} = 3.5 \ m A^{(4)}$
V _{OL1}	Output Low Voltage, port 0 ⁽⁶⁾			0.3 0.45 1.0	V V V	$I_{OL} = 200 \ \mu A^{(4)}$ $I_{OL} = 3.2 \ m A^{(4)}$ $I_{OL} = 7.0 \ m A^{(4)}$
V _{OL2}	Output Low Voltage, ALE, PSEN			0.3 0.45 1.0	V V V	$I_{OL} = 100 \ \mu A^{(4)}$ $I_{OL} = 1.6 \ m A^{(4)}$ $I_{OL} = 3.5 \ m A^{(4)}$

Table 28., Table 31. and Table 34. give the frequency derating formula of the AC parameter. To calculate each AC symbols, take the x value corresponding to the speed grade you need (-M, -V or -L) and replace this value in the formula. Values of the frequency must be limited to the corresponding speed grade:

Table 25. Max frequency for derating formula regarding the speed grade

	-M X1 mode	-M X2 mode	-V X1 mode	-V X2 mode	-L X1 mode	-L X2 mode
Freq (MHz)	40	20	40	30	30	20
T (ns)	25	50	25	33.3	33.3	50

Example:

 T_{LLIV} in X2 mode for a -V part at 20 MHz (T = 1/20^{E6} = 50 ns):

```
x= 22 (Table 28.)
```

T= 50ns

T_{LLIV}= 2T - x = 2 x 50 - 22 = 78ns

External Program Memory Characteristics

Table 26. Symbol Description

Symbol	Parameter
Т	Oscillator clock period
T _{LHLL}	ALE pulse width
T _{AVLL}	Address Valid to ALE
T _{LLAX}	Address Hold After ALE
T _{LLIV}	ALE to Valid Instruction In
T _{LLPL}	ALE to PSEN
T _{PLPH}	PSEN Pulse Width
T _{PLIV}	PSEN to Valid Instruction In
T _{PXIX}	Input Instruction Hold After PSEN
T _{PXIZ}	Input Instruction FloatAfter PSEN
T _{PXAV}	PSEN to Address Valid
T _{AVIV}	Address to Valid Instruction In
T _{PLAZ}	PSEN Low to Address Float





Speed		M MHz	X2 n 30 l 60 l	V node MHz MHz uiv.	stan mod	V dard le 40 Hz	X2 n 20 l 40 l	L node MHz MHz uiv.	stan mo	L dard ode MHz	Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Т	25		33		25		50		33		ns
T _{LHLL}	40		25		42		35		52		ns
T _{AVLL}	10		4		12		5		13		ns
T _{LLAX}	10		4		12		5		13		ns
T _{LLIV}		70		45		78		65		98	ns
T _{LLPL}	15		9		17		10		18		ns
T _{PLPH}	55		35		60		50		75		ns
T _{PLIV}		35		25		50		30		55	ns
T _{PXIX}	0		0		0		0		0		ns
T _{PXIZ}		18		12		20		10		18	ns
T _{AVIV}		85		53		95		80		122	ns
T _{PLAZ}		10		10		10		10		10	ns

Table 28. AC Parameters for a Variable Clock: derating formula

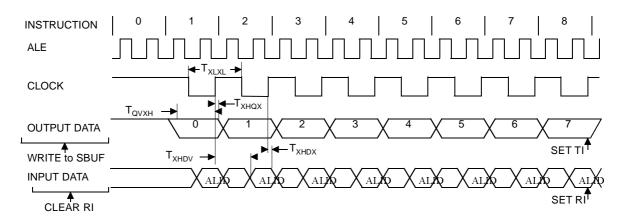
Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T _{LHLL}	Min	2 T - x	T - x	10	8	15	ns
T _{AVLL}	Min	T - x	0.5 T - x	15	13	20	ns
T _{LLAX}	Min	T - x	0.5 T - x	15	13	20	ns
T _{LLIV}	Max	4 T - x	2 T - x	30	22	35	ns
T _{LLPL}	Min	T - x	0.5 T - x	10	8	15	ns
T _{PLPH}	Min	3 T - x	1.5 T - x	20	15	25	ns
T _{PLIV}	Max	3 T - x	1.5 T - x	40	25	45	ns
T _{PXIX}	Min	х	х	0	0	0	ns
T _{PXIZ}	Max	T - x	0.5 T - x	7	5	15	ns
T _{AVIV}	Max	5 T - x	2.5 T - x	40	30	45	ns
T _{PLAZ}	Max	x	х	10	10	10	ns

Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T _{XLXL}	Min	12 T	6 T				ns
T _{QVHX}	Min	10 T - x	5 T - x	50	50	50	ns
T _{XHQX}	Min	2 T - x	T - x	20	20	20	ns
T _{XHDX}	Min	х	х	0	0	0	ns
T _{XHDV}	Max	10 T - x	5 T- x	133	133	133	ns

Table 34. AC Parameters for a Variable Clock: Derating Formula

Shift Register Timing Waveforms









EPROM Programming and Verification Characteristics

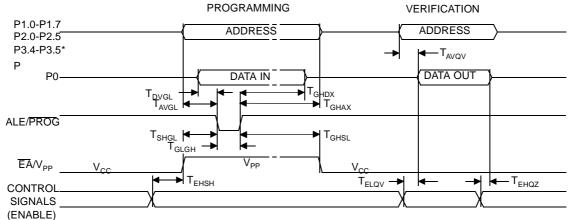
 T_A = 21°C to 27°C; V_{SS} = 0V; $~V_{CC}$ = 5V \pm 10% while programming. V_{CC} = operating range while verifying.

 Table 35.
 EPROM Programming Parameters

Symbol	Parameter	Min	Мах	Units
V _{PP}	Programming Supply Voltage	12.5	13	V
I _{PP}	Programming Supply Current		75	mA
1/T _{CLCL}	Oscillator Frquency	4	6	MHz
T _{AVGL}	Address Setup to PROG Low	48 T _{CLCL}		
T _{GHAX}	Adress Hold after PROG	48 T _{CLCL}		
T _{DVGL}	Data Setup to PROG Low	48 T _{CLCL}		
T _{GHDX}	Data Hold after PROG	48 T _{CLCL}		
T _{EHSH}	(Enable) High to V _{PP}	48 T _{CLCL}		
T _{SHGL}	V _{PP} Setup to PROG Low	10		μs
T _{GHSL}	V _{PP} Hold after PROG	10		μs
T _{GLGH}	PROG Width	90	110	μs
T _{AVQV}	Address to Valid Data		48 T _{CLCL}	
T _{ELQV}	ENABLE Low to Data Valid		48 T _{CLCL}	
T _{EHQZ}	Data Float after ENABLE	0	48 T _{CLCL}	

EPROM Programming and Verification Waveforms

Figure 22. EPROM Programming and Verification Waveforms



* 8KB: up to P2.4, 16KB: up to P2.5, 32KB: up to P3.4, 64KB: up to P3.5

Ordering Information

Table 37. Possible Ordering Entries

Part Number ⁽³⁾	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS80C32X2-MCA	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-MCB	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-MCC	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-MCE	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-LCA	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-LCB	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-LCC	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-LCE	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-VCA	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PDIL40	Stick
TS80C32X2-VCB	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PLCC44	Stick
TS80C32X2-VCC	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PQFP44	Tray
TS80C32X2-VCE	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	VQFP44	Tray
TS80C32X2-MIA	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-MIB	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-MIC	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-MIE	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-LIA	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-LIB	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-LIC	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-LIE	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-VIA	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PDIL40	Stick
TS80C32X2-VIB	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PLCC44	Stick
TS80C32X2-VIC	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PQFP44	Tray
TS80C32X2-VIE	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	VQFP44	Tray
AT80C32X2-3CSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PDIL40	Stick
AT80C32X2-SLSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PLCC44	Stick
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tray
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tape & Reel
AT80C32X2-3CSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PDIL40	Stick
AT80C32X2-SLSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PLCC44	Stick





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